Application. No. 10/582,556

/DB/ 08/26/2009

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Tomofumi MAEKAWA

Confirmation No.: 9960

Group Art Unit: 1796

Serial No

: 10/582,556 (National Stage of PCT/JP2004/018388)

I.A. Filed

: December 9, 2004

Examiner: David Buttner

For

: THERMOPLASTIC RESIN HAVING RIGIDITY WHEN HEATED

## RESPONSE UNDER 37 C.F.R. § 1.116

Commissioner of Patents
U.S. Patent and Trademark Office
Customer Window, Mail Stop <u>AMENDMENT</u>
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

This paper responds to the Office Action mailed June 8, 2009, which sets a three-month shortened statutory period for response, to end September 8, 2009. Applicants timely file this paper on or before September 8, 2009. Applicants authorize the Office to charge any additional fees to Deposit Account No. 19-0089.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 7 of this paper.